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Exam Init	Ref	Document Number	Issue Date	Name	Class	Sub- Class
<u>PN</u>	_____	5,566,083	10/15/96	Fang		
<u>PN</u>	_____	5,261,153	11/16/93	Lucas		
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Document Number	Publication Date	Country	Name
<u>PN</u> _____	00 78105	12/21/00	WO Teradyne Inc.

OTHER DOCUMENTS

Exam Init	Ref	(Including Author, Title, Date, Pertinent Pages, etc.)
<u>PN</u>	_____	Markstein, H.W.: "Ensuring Signal Integrity in Connectors, Cables, and Backplanes," Electronic Packaging and Production; Vol. 36, No. 11; October 1, 1996, pp. 61-69.

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Examiner: Patricia Nguyen

Date Considered: 11/11/2003